

NOV 14 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Yew

Docket No.: TI-26239.1

Serial No.: 10/612,129

Examiner: Cao, Phat X.

Filed: 7/2/2003

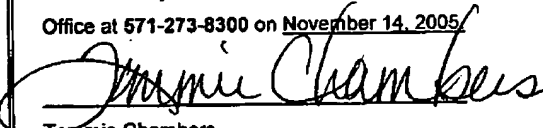
Art Unit: 2814

For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC
SUBSTRATE

PRELIMINARY AMENDMENT

Honorable Assistant Commissioner
of Patents

Washington, D.C. 20231

<p><u>CERTIFICATION OF FACSIMILE TRANSMISSION</u></p> <p>I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 571-273-8300 on <u>November 14, 2005</u>.</p> <p> Terrie Chambers</p>
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Prior to the examination of the above identified application, please amend the
above referenced Application as follows: